

J655-VB Datasheet P-Channel 100 V (D-S) MOSFET

PRODUCT	SUMMARY		
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)
- 100	0.100 at V _{GS} = - 10 V	- 23	11.7
- 100	0.120 at V _{GS} = - 4.5 V	- 20	11.7

FEATURES

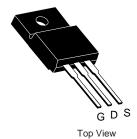
- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- 100 % R_g and UIS Tested
 Compliant to RoHS Directive 2002/95/EC

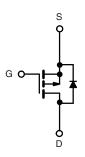


APPLICATIONS

- Power Switch
- DC/DC Converters







P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_C = 25 ^{\circ}C$, unless oth	erwise noted		
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	- 100	V
Gate-Source Voltage		V_{GS}	± 20	7 v
Continuous Drain Current (T _{.I} = 150 °C)	T _C = 25 °C	L	- 23	
Continuous Diam Current (1) = 150 C)	T _C = 70 °C	I _D	- 16	7
Pulsed Drain Current	I _{DM}	- 70	_ A	
Avalanche Current	I _{AS}	- 18		
ingle Avalanche Energy ^a L = 0.1 mH		E _{AS}	16.2	mJ
	T _C = 25 °C	В	52.1 ^b	14/
Maximum Power Dissipation ^a	T _A = 25 °C ^c	$ P_D$	2.5	W
Operating Junction and Storage Temperature Ra	nge	T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	50	°C/W
Junction-to-Case (Drain)	R _{thJC}	3.9	C/VV

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When Mounted on 1" square PCB (FR-4 material).



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{DS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$	- 100			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 2.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 250	nA	
		V _{DS} = - 100 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 100 V, V _{GS} = 0 V, T _J = 125 °C			- 50	μΑ	
		V _{DS} = - 100 V, V _{GS} = 0 V, T _J = 150 °C			- 250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -10 \text{ V}, V_{GS} = -10 \text{ V}$	- 15			Α	
Drain-Source On-State Resistance ^a	Ь	V _{GS} = - 10 V, I _D = - 3.6 A		0.100		Ω	
	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 3.4 A		0.120			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 3.6 A		12		S	
Dynamic ^b							
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = - 50 V, f = 1 MHz		1055		pF	
Output Capacitance	C _{oss}			65			
Reverse Transfer Capacitance	C _{rss}]		41			
Tatal Cata Charma ^C	Q_g	V _{DS} = - 50 V, V _{GS} = - 10 V, I _D = - 3.6 A		23.2	34.8	nC	
Total Gate Charge ^c				11.7	17.6		
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = -50 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -3.6 \text{ A}$		3.5			
Gate-Drain Charge ^c	Q_{gd}			4.8			
Gate Resistance	R_g	f = 1 MHz	1.2	5.7	11.5	Ω	
Turn-On Delay Time ^c	t _{d(on)}			7	14		
Rise Time ^c	t _r	$V_{DD} = -50 \text{ V}, R_{L} = 17.2 \Omega$		12	18	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 2.9 A, V_{GEN} = - 10 V, R_g = 1 Ω		33	50		
Fall Time ^c	t _f	1		9	18	1	
Drain-Source Body Diode Ratings at	nd Characteri	stics T _C = 25 °C ^b					
Continuous Current	I _S				- 8.8	•	
Pulsed Current	I _{SM}				- 15	A	
Forward Voltage ^a	V _{SD}	I _F = - 2.9 A, V _{GS} = 0 V		- 0.8	- 1.5	٧	
Reverse Recovery Time	t _{rr}			50	75	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 2.9 A, dl/dt = 100 A/μs		- 4	- 6	Α	
Reverse Recovery Charge	Q _{rr}	1		98	147	nC	

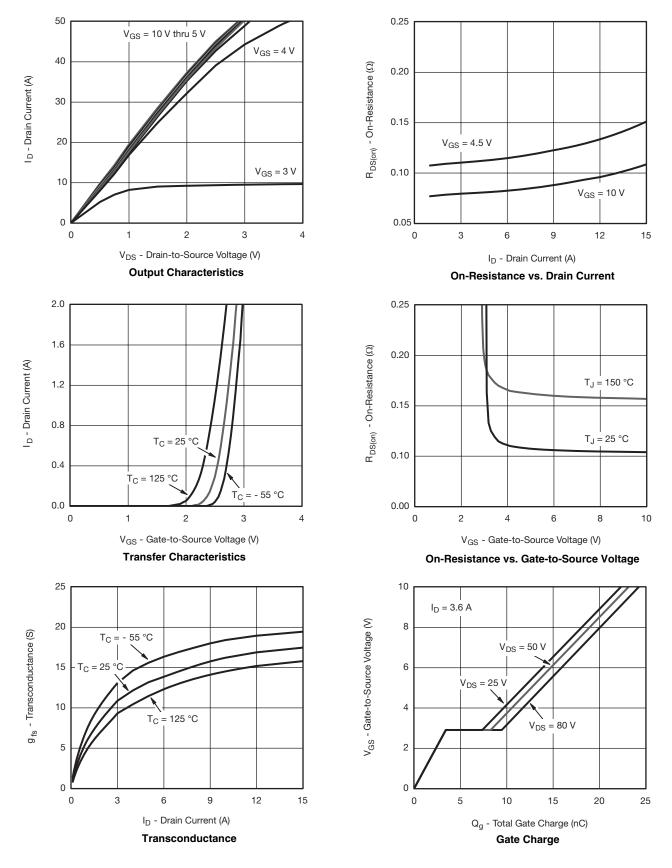
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

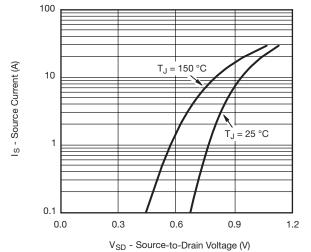


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

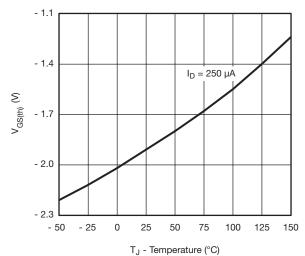




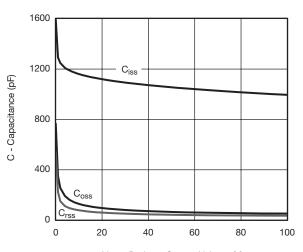
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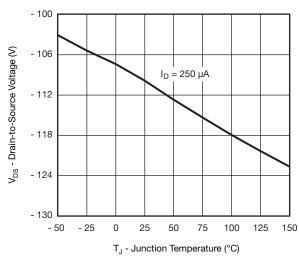
Source-Drain Diode Forward Voltage



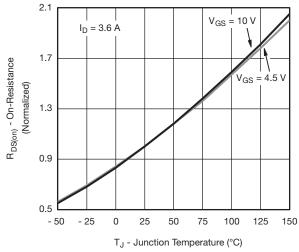
Threshold Voltage



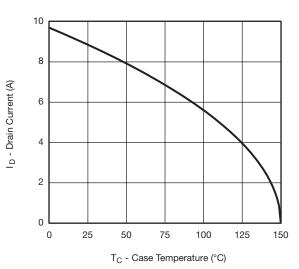
 V_{DS} - Drain-to-Source Voltage (V) $\label{eq:capacitance}$



Drain Source Breakdown vs. Junction Temperature



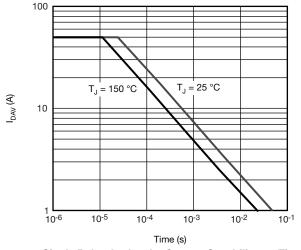
On-Resistance vs. Junction Temperature

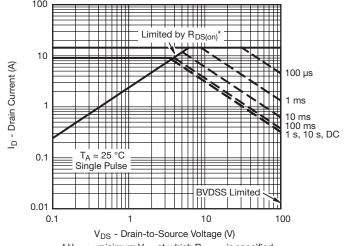


Current Derating

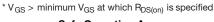


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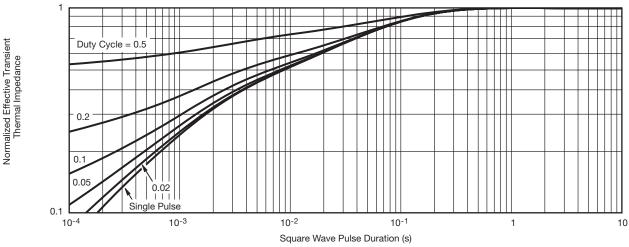




Single Pulse Avalanche Current Capability vs. Time







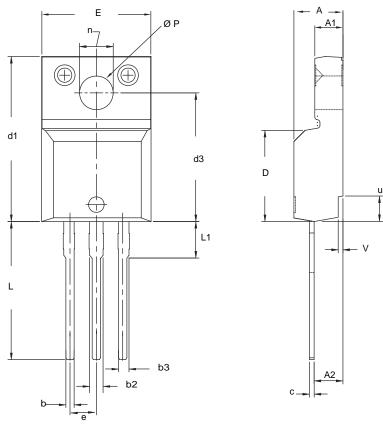
Normalized Thermal Transient Impedance, Junction-to-Case

服务热线:400-655-8788

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TO-220 FULLPAK



DIM.	MILLI	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.	
Α	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
Е	10.360	10.630	0.408	0.419	
е	2.54	2.54 BSC		0.100 BSC	
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØΡ	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

DWG: 5972

- To be used only for process drawing.
 These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads.
 All critical dimensions should C meet C_{pk} > 1.33.
 All dimensions include burrs and plating thickness.
 No chipping or package damage.



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